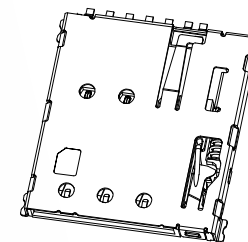
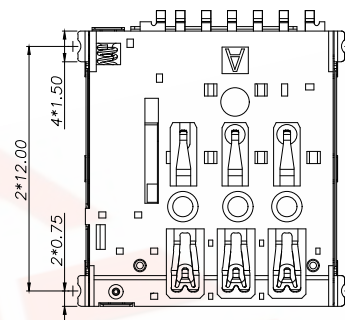
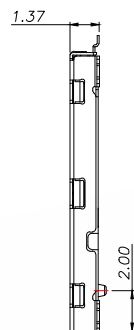
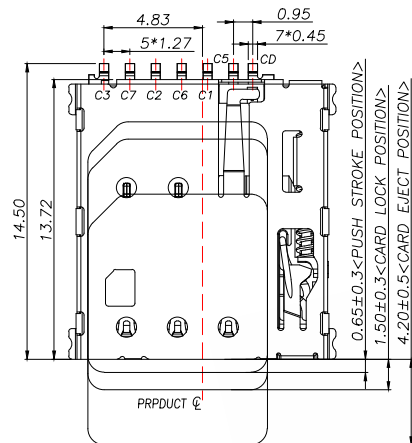
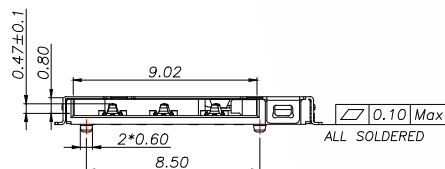


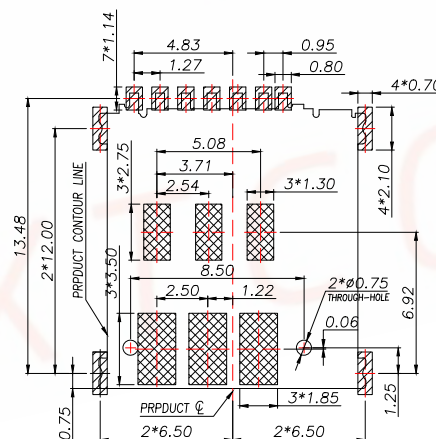
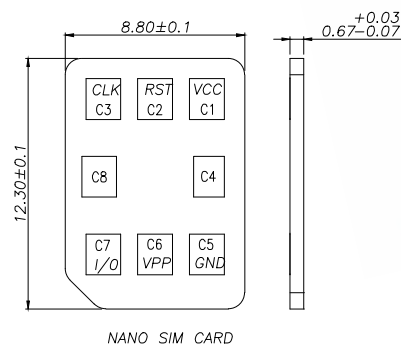
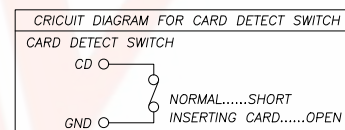
REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



3D VIEW



PIIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
CD	Detect Switch
C5	GND
C6	VPP
C7	I/O



RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)
RECOMMENDED MATAL MASK T=0.12mm

Legend:
SMT SOLDER AREA
NO PATTERN AND VIA HOLE IN HTIS AREA

NOTES:

1.MATERIAL:

HOUSING: High Temperature Thermoplastic

Terminal: Copper

Shell: Stainless Steel

2.PLATING:

Terminal:50u" Ni UNDERPLATED OVERALL

G/F PLATED ON CONTACT AREA AND SOLDER AREA

Shell:30u" Ni UNDERPLATED OVERALL

G/F PLATED ON CONTACT AREA AND SOLDER AREA

3.technical SPECIALITY:

RATED VOLTAGE: 30V AC MAX.

CURRENT RATING: 0.5A MAX.

INSULATION RESISTANCE:1000MΩ MIN

CONTACT REISTANCE:50mΩ MAX

WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTES

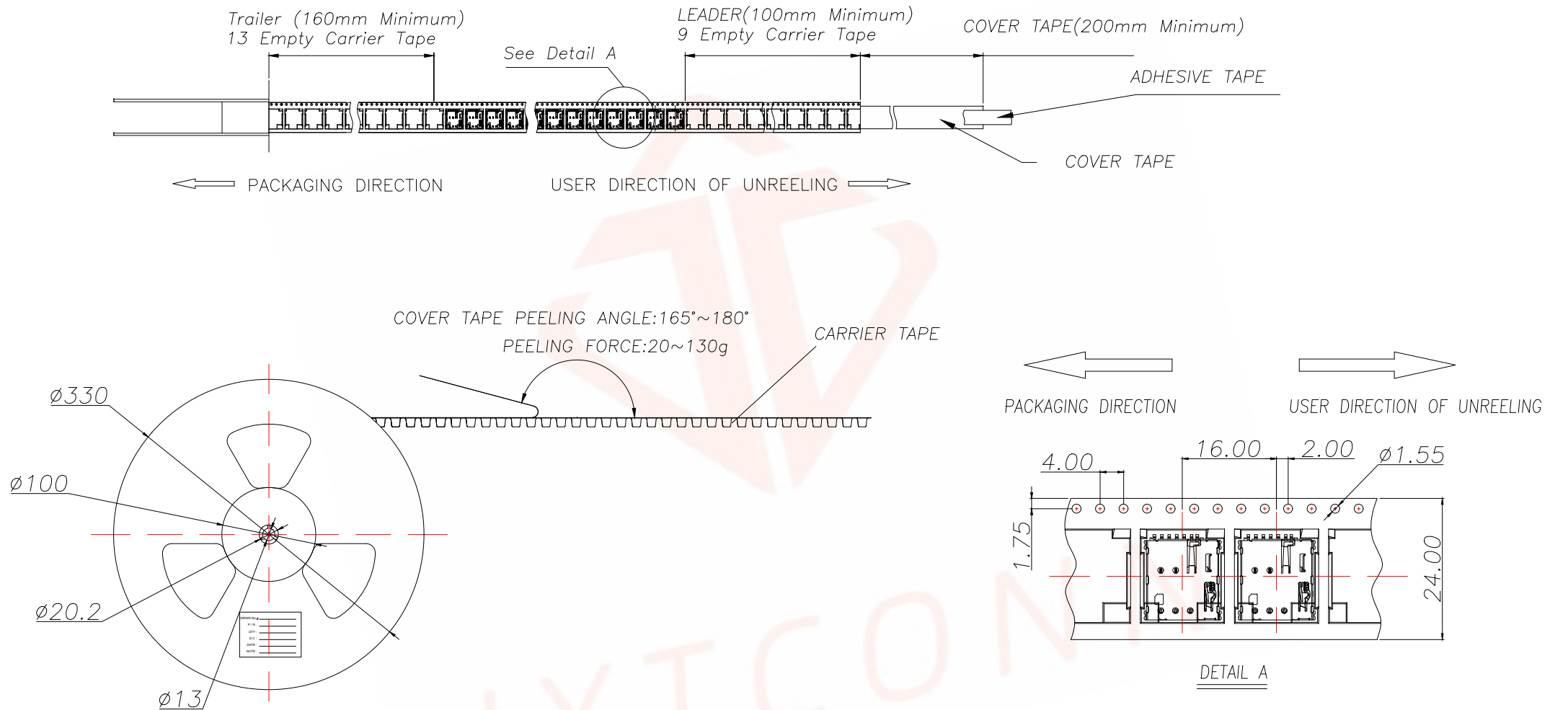
OPERATING TEMPERATURE: -40℃~+85℃

Humidity 80% R.H MAX

4.DIMENSIONS WITH MARK * "MUST BE MEASURE BY QC AND IPQC

TOLERANCE		 深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
X.:±0.35	X'.:±2"	PART NO. CSIM-H137-7P	TITLE: NANO SIM CARD 1.37H PUSH PUSH 有柱		
.X:±0.15	.X'.:±1"				
.XX:±0.10	.XX'.:±0.5"				
UNITS	mm	DESIGN: Ethan	MANUFACTURE DWG		
MATERILA	— — —	CHED: Olvia			
FINISH	— — —	APPD: Ava			

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



1	CSIM-H137-7P	1500	10		15000	350X350X340
ITEM	PRODUCT NO	QTY/REEL	REEL/CARTON	Kg/CARTON	QTY/CARTON	CARTON SIZE

TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd	
X.:±0.35	X':±2"	PART NO.	TITLE: NANO SIM CARD
.X:±0.15	.X':±1"	CSIM-H137-7P	1.37H PUSH PUSH 有柱
.XX:±0.10	.XX':±0.5"	DESIGN: Ethan	MANUFACTURE DWG
UNITS	mm	CHED: Olvia	SCALE SHEET N:A 1/1
MATERILA	---	APPD: Ava	
FINISH	---		